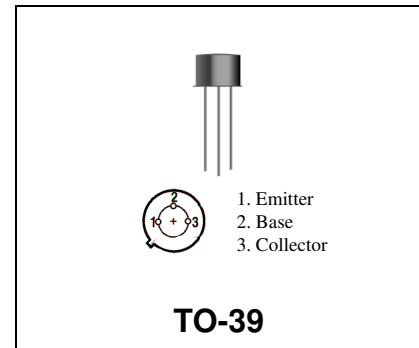


RF & MICROWAVE DISCRETE LOW POWER TRANSISTORS

Features

- Silicon NPN, high Frequency, high breakdown Transistor
- Maximum Unilateral Gain = 13.5 dB (typ) @ f = 200 MHz
- High Collector Base Breakdown Voltage - BVCBO = 100 V (min)
- High F_T - 1400 MHz



DESCRIPTION:

Designed primarily for use in high frequency and medium and high resolution color video display monitors as well as other applications requiring high breakdown characteristics.

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C)

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	70	Vdc
V _{CBO}	Collector-Base Voltage	100	Vdc
V _{EBO}	Emitter-Base Voltage	3.0	Vdc
I _c	Collector Current	400	mA

Thermal Data

P _D	Total Device Dissipation @ T _A = 25°C Derate above 25°C	3.5 20	Watts mW/ °C
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ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)
**STATIC
(off)**

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
BVCEO	Collector-Emitter Breakdown Voltage (I _C = 1.0 mA _{dc} , I _B = 0)	70	-	-	V _{dc}
BVCBO	Collector-Base Breakdown Voltage (I _C = 100 μA _{dc} , I _E = 0)	100	-	-	V _{dc}
BVEBO	Emitter-Base Breakdown Voltage (I _E = 100 μA _{dc} , I _C = 0)	3.0	-	-	V _{dc}
ICBO	Collector Cutoff Current (V _{CE} = 80 V _{dc} , I _E = 0 V _{dc})	-	-	20	μA
ICES	Collector Cutoff Current (V _{CE} = 80 V _{dc} , I _E = 0 V _{dc})	-	1.0	100	μA

(on)

HFE	DC Current Gain (I _C = 50 mA _{dc} , V _{CE} = 6.0 V _{dc})	15	-	-	-
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DYNAMIC

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
COB	Output Capacitance (V _{CB} = 10V _{dc} , I _E = 0, f = 1 MHz)	-	2.5	-	pF
CIB	Input Capacitance (V _{EB} = 3V _{dc} , I _E = 0, f = 1 MHz)	-	6.1	-	pF
f _T	Current-Gain - Bandwidth Product (I _C = 50 mA _{dc} , V _{CE} = 10 V _{dc} , f = 250 MHz)	1000	1500	-	MHz

FUNCTIONAL

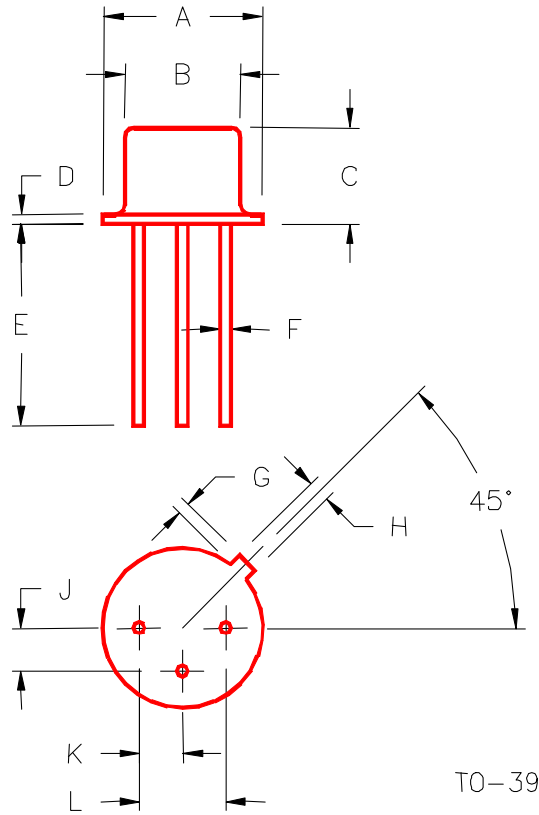
Symbol	Test Conditions		Value			Unit
			Min.	Typ.	Max.	
$G_{U\max}$	Maximum Unilateral Gain	IC = 50 mAdc, VCE = 25Vdc, f = 200 MHz	-	13.5	-	dB
MAG	Maximum Available Gain	IC = 50 mAdc, VCE = 25Vdc, f = 200 MHz	-	13.5	-	dB
$ S_{21} ^2$	Insertion Gain	IC = 50 mAdc, VCE = 25Vdc, f = 200 MHz	11.7	12.7	-	dB

Table 1. Common Emitter S-Parameters, @ VCE = 25 V, IC = 50 mA

f (MHz)	S11		S21		S12		S22	
	S11	$\angle \phi$	S21	$\angle \phi$	S12	$\angle \phi$	S22	$\angle \phi$
100	0.221	-143	8.54	97	0.047	82	0.508	14
200	0.219	-108	4.36	87	0.091	87	0.413	49
300	0.250	-72	2.98	79	0.141	87	0.406	82
400	0.329	-34	2.39	72	0.178	84	0.445	108
500	0.338	9	2.11	70	0.237	87	0.409	140
600	0.348	51	1.83	65	0.292	86	0.412	176
700	0.371	94	1.61	61	0.35	86	0.411	-147
800	0.374	140	1.44	59	0.383	85	0.413	-112
900	0.402	-170	1.45	63	0.428	88	0.386	-78
1000	0.438	-126	1.56	64	0.503	86	0.405	-42

MRF544

PACKAGE STYLE M246



TO-39

	MINIMUM INCHES/MM	MAXIMUM INCHES/MM		MINIMUM INCHES/MM	MAXIMUM INCHES/MM
A	.350/8,89	.370/9,40	J	.095/2,41	.105/2,67
B	.315/8,00	.335/8,51	K	.095/2,41	.105/2,67
C	.240/6,10	.260/6,60	L	.190/4,83	.210/5,33
D	.015/0,38	.045/1,14			
E	.500/12,70				
F	.016/0,41	.019/0,48			
G	.029/0,74	.040/1,02			
H	.028/0,71	.034/0,86			